

**REGULAR
PAPER PREPARATION KIT FOR THE
CUSTOM INTEGRATED CIRCUITS CONFERENCE**
May 12-15, 2002, Caribe Royale Hotel, Orlando, FL

Dear Author(s):

We appreciate your interest in submitting a paper to the Custom Integrated Circuits Conference, May 12-15, 2002, in Orlando, FL. The Conference is following a policy of reviewing the complete camera-ready papers instead of preliminary abstracts. **The accepted papers will be printed in the CICC Conference Proceedings and CD ROM as submitted, without opportunity for further changes.** Enclosed in this Paper Preparation Kit you will find all the necessary information and forms for the preparation of your submitted paper.

Authors presenting papers at the CICC Conference will be required to use an electronic projection medium (to be described in more detail in a later correspondence).

In order to insure that your submitted paper receives a complete review it is imperative that you follow all the instructions and submit all the required documentation. Enclosed to assist you are:

1. GENERAL GUIDELINES that address the deadlines and required documentation
2. AUTHOR'S GUIDE that provides a detailed description of camera-ready paper preparation
3. TECHNICAL CATEGORIES for paper submission
4. SAMPLE OF A COMPLETED PAGE
5. COPYRIGHT RELEASE FORM giving the conference permission to print the paper if accepted

The deadline for submission of camera-ready papers is November 28, 2001. Your cover letter, camera-ready paper (**plus 25 copies**), 50 word abstract, PDF copy of the paper on a floppy disk and copyright release form **NEED TO ARRIVE** at the Conference Office by that date. **PLEASE REMEMBER THAT YOUR COMPLETED PAPER MUST OCCUPY NO MORE THAN FOUR PAGES (or 1.44MB).**

The Technical Program Committee will review all submitted papers and authors will receive notification of the Committee's decision on or about January 31, 2002. We thank you for your interest in the CICC. If at any time a question exists, please don't hesitate to contact the Conference Office at 301/527-0900 x207 or email to cicc@his.com

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Larry Starr
Technical Program Chairman
Custom Integrated Circuit Conference

Enclosures

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 - The abstract is a brief synopsis of your paper. Accepted paper abstracts will be posted on the CICC home page. The abstract should be prepared on a separate page with title of the paper, authors, affiliations, city, state, and country at the top.
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Your cover letter, camera-ready paper (plus 25 copies), PDF file, 50 word abstract, and copyright form must be mailed **to reach** the Conference Office by November 28, 2001. **Please remember that your manuscript must be camera-ready; it will be photographed and printed as it is received. THERE WILL BE NO OPPORTUNITY TO MAKE CHANGES OF ANY SORT TO THE ACCEPTED MANUSCRIPT.**

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AUTHOR'S GUIDE

Preparation of Papers in Two-Column Format for the CICC

Center the Authors Names Here

Center the Affiliations Here

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(it is your option if you want your entire address listed)

Abstract

The abstract is a brief (50 - 80 word) synopsis of your paper. It's use is to provide a quick outline of your presentation, giving the reader an overview of the research. This is an important aspect of your paper as it is this description that may attract the reader to continue and finish reading your full report.

Introduction

These instructions give you basic guidelines for preparing camera-ready (CR) papers for the CICC. The instructions assume that you have computer desktop publishing equipment with several fonts. If you do not, and will be using a typewriter to prepare your paper, use 75% reduction mats (contact the CICC for mats).

Your goal is to simulate, as closely as possible, the usual appearance of published papers in the CICC Conference Proceedings. These instructions have been prepared in the preferred format.

How to Format the Page

A. Full-Size Camera-Ready (CR) Copy

Prepare your CR paper in full-size format, on paper 8 1/2" x 11" (21.5cm x 27.9cm). If you are using A4 (metric) size paper, please cut the paper length to 28cm before you print the text.

B. Fonts

The best results will be obtained if your computer word-processor has several font sizes. Try to follow the font sizes specified in Table I as best you can. As an aid to gauging font size, 1 point is about 0.35mm. Use a proportional, serif font such as Times or Dutch Roman.

TABLE I
FONT SIZES FOR CAMERA-READY PAPERS

Font Size	Bold	Italic	Text
10			Main Text, Authors Affiliations
10	Yes		Headings, i.e., Abstract
12			Authors' names
14	Yes		Paper title
10		Yes	Subheadings, i.e., <i>Fonts</i>
8	Yes		Section titles, references, tables table names, table captions, figure captions, footnotes, sub-and superscripts

C. Format

In formatting your paper, set top and bottom margins to 1 inch (25mm) and left and right margins to 0.70 inches (19mm). If you are using A4 paper, set the right margin to 12mm. The column width is 3.45 inches (88mm) with 0.2 inches (5mm) space between the two columns.

You should left- and right-justify your columns. On the last page of your paper, try to adjust the lengths of the two columns so that they are the same. Use automatic hyphenation if you have it. Don't forget to check spelling.

Single space between a heading and the following text. Double space between text and the following heading.

Number each of your submitted pages at the top, right corner, in non-photographic light blue pencil.

D. Reduction Mats

If you have only typewriter fonts available, use 75% reduction mats (model paper). **Contact the CICC Office immediately (telephone: 301/527-0900, fax: 301/527-0994) and mats will be sent to you.**

Illustrations

Position figures and tables at the tops and bottoms of columns if possible. Large figures and tables may span both columns. Figure captions should be below the figures; table captions should be above the tables. Try to place the figures and tables after their first mention in the text. Use the abbreviation (e.g., "Fig. 1") even at the beginning of a sentence.

All halftone illustrations (pictures/photographs) should be clear black and white prints. Do not use photocopies. These illustrations should be furnished within the copy, or if necessary, as separate 8" x 10" prints, in which case a blank space of proper proportions must be allowed within the copy. Halftone illustrations not so designated will be placed at the end of the respective paper. Make certain to include a caption in the paper for the illustration as well as to label the illustration on the back.

Helpful Hints

A. References

List and number all references at the end of the paper. When

referring to them in the text, type the corresponding reference number in parentheses as shown at the end of this sentence (1). Number the citations consecutively. The sentence punctuation follows the parentheses. Do not use "Ref. (3)" or "reference (3)" except at the beginning of a sentence.

Number the footnotes separately in superscripts¹. Place the actual footnote at the bottom of the column in which it is cited. Do not put footnotes in the reference list.

Give all authors' names; do not use "et al" unless there are six authors or more. Papers that have not been published, even if they have been submitted for publication, should be cited as "unpublished" (10). Papers that have been accepted for publication should be cited as "in press" (11). Capitalize only the first word in a paper title, except for proper nouns and element symbols.

For papers published in translation journals, please give the English citation first, followed by the original foreign-language citations (12).

B. Abbreviations and Acronyms

Define abbreviations and acronyms the first time they are used. Acronyms such as MOSFET, ac and dc do not have to be defined. Define acronyms when first used in the text even if they have been defined subsequently in the paper.

C. Equations

Number equations consecutively with equation numbers in parentheses flush with the right margin, as in (1). To make your equations more complex, you may use the solidus (/), the exp function, or appropriate exponents. Italicize Roman symbols for quantities and variables, but not Greek symbols. Use a long dash rather than a hyphen for a minus sign. Use parentheses to avoid ambiguities in denominators. Punctuate equations with commas or periods when they are part of a sentence.

Be sure that the symbols in your equation have been defined before the equation appears or immediately following. When you refer to equations in the text, refer to (1). Do not use "Eq. (1)" or "Equation (1)" except at the beginning of a sentence: Equation (1) is used...

D. Other Recommendations

Use either one or two spaces between sections, and between text and tables or figures, to manipulate the column length. Use two spaces after periods at the end of sentences (full stops).

References

- (1) G. Eason, B. Noble, and I.N. Sneddon, "On certain integrals of Lipschitz-Hankel type involving products of Bessel functions," *Phil. Trans. Roy. Soc. London*, vol. A247, pp. 529-551, April 1955.
- (2) J. Clerk Maxwell, *A Treatise on Electricity and Magnetism*, 3rd ed., Vol. 2, Oxford: Clarendon Press, 1892, pp. 68-73.
- (3) I.S. Jacobs and C.P. Bean, "Fine particles, thin films and exchange anisotropy," in *Magnetism*, Vol. III, G. T. Rado and H. Suhl, Eds., New York: Academic Press, 1963, pp. 271-350.
- (10) M. Smith, "Title of paper optional here," unpublished.
- (11) K. Rose, "Title of paper with only first word capitalized," in press.
- (12) Y. Yorozu, M. Hirano, K. Oka, and Y. Tagawa, "Electron spectroscopy studies on magneto-optical media and plastic substrate interface," *IEEE Trans. J. Magn. Japan*, vol. 2, pp. 740-741, August 1987 [*Digests 9th Annual conf. Magn. Japan*, p. 3012, 1982]

TECHNICAL CATEGORIES

PAPERS IN THE FOLLOWING AREAS ARE REQUESTED:

<i>Analog Circuit Design</i>	Data converters, modulators, filters, high-speed analog, low- voltage techniques. Mixed analog-digital IC applications, RAMDACs, advanced read/write channel circuits. ICs and systems for data, voice, image and video transmissions. Analog, digital and mixed-signal innovations for modulation, equalization, error correction, coding, switching, auto calibration, adaptive signal processing. Circuits for wired and wireless communications. Circuits for SONET/SDH, xDSL, LAN/WAN/ATM, set-top receivers, cable modems, high-speed serial links and broadband applications. Receivers, transmitters, and their subcircuits for RF/IF/baseband, frequency synthesis, phase-locked loops, wireless LAN, baseband/RF power amplifiers.
<i>Custom /Low-Power</i>	Custom circuit designs including low-power design techniques, on-chip power management, and voltage conversion. Innovative designs for cell-based or full custom ICs for applications such as automotive, biomedical, and specialized consumer products. Sensor interface circuits and high-performance digital cells, clocking circuits, and I/O circuits.
<i>DSP</i>	Error correction and modulation techniques to increase the speed and bandwidth of optical and wireless transmission systems. Configurable DSP architectures, including network processors. Digital video and audio, MPEG, image recognition and enhancement. Audio coding and speech recognition. Specialized processing function architectures. Digital filtering, encryption, HDTV, video conferencing, multimedia, graphics controllers, video drivers, and novel DSP algorithm implementations.
<i>Embedded Memory</i>	Use of SRAM, DRAM, EEPROM, ROM and CAM in ICs. Innovative memory architectures, sense amplifiers, special memory interfaces, and design of memories in new technologies such as SOI or ferroelectric material.
<i>Fabrication / Foundry</i>	Advanced process integration techniques for the manufacturing & prototyping of system-on-a-chip ICs using any combination of CMOS, bipolar, BiCMOS, SiGe, SOI, smart power, ferroelectrics, and MEMS technologies. New and evolving chip packaging such as BGA, flip-chip, chip-on-chip, and multi-chip modules. Package modeling, techniques, ESD protection, and fiber optic transceivers.
<i>Programmable Devices</i>	FPGA/PLD logic block, routing, and system block architectures and circuitry. Programmable I/O structures, configurable cores, interaction between configurable logic and processors/memories/fixed-function cores. CAD tools targeting these devices.
<i>Simulation-Modeling</i>	System, circuit, functional, timing, and logic simulation. Device and block modeling. Analog, RF modeling and simulation. Mixed-signal simulation and modeling, or analog/digital interfaces. Signal integrity and reliability verification. Clock/power network design, synthesis and verification. R(L)C extraction, data reduction and analysis. Modeling of device/interconnect packaging and process/process variations.
<i>System-on-a-Chip</i>	System-on-a-chip (SoC) design, integration of diverse silicon IP and technologies (e.g., embedded DRAM of Flash, analog/mixed-signal blocks, programmable logic) on the same IC. Silicon-IP and SoC design flows including system-level design tools and techniques. Silicon-IP generation, verification and protection. IC design technical project management, estimating design and CAD support resources, global design teams.
<i>Test and Reliability</i>	ATE and ad-hoc test techniques, design for test and reliability for analog, digital and SoC designs. Circuit techniques to aid failure analysis for advanced CMOS processes. Testing, reliability impact, and circuit implications of radiation-induced soft errors.

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AUTHORS (S):

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